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To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof	
<ul> <li>1. Name of conveying party(ics)</li> <li>Klaus GESSNER</li> <li>Additional name(s) of conveying parties attached?</li> <li>□ Yes   No</li> </ul>	2. Name and address of receiving party(ies)  **T* Name: Siemens Address:  Street Address:
3. Nature of conveyance:	Wittelsbacherplatz 2 80333 Munchen, Federal Republic of Germany  Additional name(s) & address(es) attached? □ Yes & No
A4. Application numbers or patent numbers:  If this document is being filed together with a new application, the execution date of the application is: March 5, 1996	
A. Patent Applications 08/535,284	B. Patent No.(s)
	08232 >61
Additional Numbers attached? □ Yes ⋈ No	
5. Name and address of party to whom correspondence concerning document should be mailed: Name: Richard L. Mayer Internal Address: KENYON & KENYON Street Address: One Broadway City: New York State: New York ZIP: 10004	6. Total number of applications and patents involved: 1  7. Total fee (37 C.F.R. 3.41)
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9. Statement and signature.  To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.  Richard L. Mayer  Name of Person Signing  Total Number of pages including cover sheet, attachments and document: 3	
OMB No. 0651-0011 (exp. 4/94)	
Mail documents to be recorded with required cover sheet information to:  Assistant Commissioner For Patents  Box Assignments  Washington DC 20231	

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**PATENT** REEL: 012542 FRAME: 0760

## A S S I G N M E N T

WHEREAS, I, Klaus GESSNER, a citizen of the Federal Republic of Germany, residing at Gartenfelder Strasse 46, 13599 Berlin, Federal Republic of Germany, have invented new and useful improvements in a PROCESS FOR PRODUCING A GAS-TIGHT SOLDERED JOINT AND USE OF THE PROCESS IN THE PRODUCTION OF COMPONENTS WITH A VACUUM-TIGHT CASING, for which I am about to make application for Letters Patent of the United States, said application having been filed as International Patent Application No. PCT/DE94/00686 on 10 June 1994; and

WHEREAS, SIEMENS AKTIENGESELLSCHAFT, organized and existing under and by virtue of the laws of the Federal Republic of Germany, having an office at Wittelsbacher-platz 2, 80333 München, Federal Republic of Germany, is desirous of acquiring the entire right, title and interest in and to the application and invention therein described and claimed and any Letters Patent that may be issued upon the application or for the improvements therein contained.

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency whereof is hereby acknowledged, I, Klaus GESSNER, have assigned and transferred, and do hereby assign and transfer, unto SIEMENS AKTIENGESELLSCHAFT, its successors and assigns, the entire right, title and interest in and to the application and the invention therein contained, including the right to apply for any Letters Patent in the United States of America on the invention, and any Letters Patent that may issue thereon or therefor in the United States, and all reissues, extensions, renewals, divisions and continuations thereof, to the full end of the term or terms for which the Letters Patent may be issued, the same to be

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held and enjoyed by SIEMENS AKTIENGESELLSCHAFT, its successors and assigns, the same as it would have been held and enjoyed by me if this Assignment had not been made.

And I hereby authorize and request the Commissioner of Patents and Trademarks to issue all such Letters Patent to SIEMENS AKTIENGESELLSCHAFT, its successors and assigns, in accordance with this instrument of Assignment.

I hereby represent and warrant that there are no rights and interests outstanding inconsistent with the rights and interests granted herein and that I will not execute any instrument or grant or transfer any rights or interests inconsistent therewith, and I, Klaus GESSNER, bind myself, my heirs, executors, administrators and legal representatives, as the case may be, to execute and deliver to SIEMENS AKTIENGESELLSCHAFT, its successors and assigns, any further documents or instruments and do any and all further acts that may be deemed necessary by SIEMENS AKTIENGESELLSCHAFT, its successors and assigns, to vest in SIEMENS AKTIENGESELLSCHAFT, its successors and assigns, the title herein conveyed, or intended so to be, and to enable such title to be recorded in the United States.

And I further covenant and agree, in consideration of the premises, that I, my executors and administrators, will at any time upon request communicate to SIEMENS AKTIENGESELLSCHAFT, its successors and assigns, any facts relating to the invention and improvements and the history thereof, known to me or my executors and administrators, and that I will testify as to the same in any interference, or other litigation when requested so to do by SIEMENS AKTIENGESELLSCHAFT, its successors and assigns.

RECORDED: 06/14/2001

PATENT REEL: 012542 FRAME: 0762